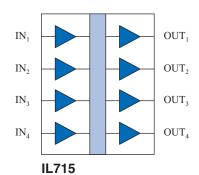
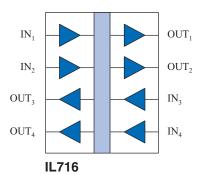
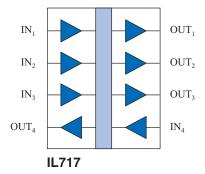


High Speed Four-Channel Digital Isolators

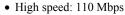
Functional Diagrams







Features



- High temperature: -40°C to +125°C (T-Series)
- 50 kV/µs typ.; 30 kV/µs min. common mode transient immunity
- No carrier or clock for low EMI emissions and susceptibility
- 1.2 mA/channel typical quiescent current
- 100 ps pulse jitter
- 2 ns channel-to-channel skew
- 10 ns typical propagation delay
- 600 V_{RMS} working voltage per VDE 0884
- 2500 V_{RMS} isolation voltage per UL 1577
- 44000 year barrier life
- · Excellent magnetic immunity
- UL 1577 recognized; IEC 60747-5-5 (VDE 0884) certified
- 0.15", 0.3", and True 8™ mm 16-pin SOIC; 16-pin QSOP packages

Applications

- ADCs and DACs
- · Digital Fieldbus
- Multiplexed data transmission
- Board-to-board communication
- Ground loop elimination
- Parallel bus
- Logic level shifting
- Equipment covered under IEC 61010-1 Edition 3
- 5 kV_{RMS} rated IEC 60601-1 medical applications

Description

NVE's IL715, IL716, and IL717 four-channel high-speed digital isolators are CMOS devices manufactured with NVE's patented* IsoLoop® spintronic Giant Magnetoresistive (GMR) technology.

A unique ceramic/polymer composite barrier provides excellent isolation and virtually unlimited barrier life.

All transmit and receive channels operate at 110 Mbps over the full temperature and supply voltage range. The symmetric magnetic coupling barrier provides a typical propagation delay of only 10 ns and a pulse width distortion of 2 ns, achieving the best specifications of any isolator.

Typical transient immunity of 50 kV/µs is unsurpassed. High channel density makes these devices ideal for isolating ADCs and DACs, parallel buses and peripheral interfaces.

The IL715, IL716, and IL717 are available in 16-pin 0.3" and 0.15" SOIC and ultraminiature QSOP packages. Performance is specified over a temperature range of -40°C to +100°C. The IL715T, IL716T, and IL717T are specified for -40°C to +125°C.

IsoLoop is a registered trademark of NVE Corporation. *U.S. Patent numbers 5,831,426; 6,300,617 and others.





Absolute Maximum Ratings

Parameters	Symbol	Min.	Тур.	Max.	Units	Test Conditions
Storage Temperature	T_{s}	-55		150	°C	
Junction Temperature	T_{J}	-55		150	°C	
Ambient Operating Temperature ⁽¹⁾ IL715T, IL716T, and IL717T	T_{A}	-40		100 125	°C	
Supply Voltage	V_{DD1}, V_{DD2}	-0.5		7	V	
Input Voltage	$V_{\rm I}$	-0.5		$V_{\rm DD} + 0.5$	V	
Output Voltage	V_{o}	-0.5		$V_{DD} + 0.5$	V	
Output Current Drive	I_{o}			10	mA	
Lead Solder Temperature				260	°C	10 sec.
ESD			2		kV	HBM

Recommended Operating Conditions

Parameters	Symbol	Min.	Тур.	Max.	Units	Test Conditions
Ambient Operating Temperature IL715T, IL716T, and IL717T	T_{A}	-40		100 125	°C	
Junction Temperature IL715T, IL716T, and IL717T	T_{J}	-40		110 125	°C	
Supply Voltage	V_{DD1}, V_{DD2}	3.0		5.5	V	
Logic High Input Voltage	$ m V_{IH}$	2.4		$ m V_{\scriptscriptstyle DD}$	V	
Logic Low Input Voltage	$V_{\scriptscriptstyle IL}$	0		0.8	V	
Input Signal Rise and Fall Times	t_{IR}, t_{IF}			1	μs	

Inculation Specifications

Parameters			Symbol	Min.	Тур.	Max.	Units	Test Conditions
Creepage Distance (external)	QSOP 0.15" SO 0.3" SO	-		4.03 4.03 8.03	8.3		mm	Per IEC 60601
Total Barrier Thickn	ess (intern	nal)		0.012	0.013		mm	
Leakage Current ⁽⁵⁾	Leakage Current ⁽⁵⁾				0.2		μΑ	$240 V_{RMS}$, $60 Hz$
Barrier Resistance ⁽⁵⁾					>10 ¹⁴		Ω	500 V
Barrier Capacitance	Barrier Capacitance ⁽⁵⁾				4		pF	f=1 MHz
Comparative Tracking	ng Index		CTI	≥175			V	Per IEC 60112
High Voltage Endur (Maximum Barrier V for Indefinite Life)		AC DC	V_{IO}	1000 1500			$V_{\scriptscriptstyle RMS}$ $V_{\scriptscriptstyle DC}$	At maximum operating temperature
Barrier Life				44000		Years	100°C, 1000 V _{RMS} , 60% CL activation energy	

Thermal Characteristics

Parameter		Symbol	Min.	Тур.	Max.	Units	Test Conditions
Junction–Ambient Thermal Resistance	QSOP 0.15" SOIC 0.3" SOIC	$\theta_{\scriptscriptstyle JA}$		60 60 60		°C/W	Soldered to double-
Junction–Case (Top) Thermal Resistance	QSOP 0.15" SOIC 0.3" SOIC	$\Psi_{ exttt{JT}}$		10 10 20		°C/W	sided board; free air
Power Dissipation	QSOP 0.15" SOIC 0.3" SOIC	$P_{\scriptscriptstyle D}$			675 700 800	mW	



Safety and Approvals

IEC 60747-5-5 (VDE 0884) (File Number 5016933-4880-0001)

- Working Voltage (V_{IORM}) 600 V_{RMS} (848 V_{PK}); basic insulation; pollution degree 2
- Transient overvoltage (V_{IOTM}) and surge voltage (V_{IOSM}) 4000 V_{PK}
- \bullet Each part tested at 1590 V_{PK} for 1 second, 5 pC partial discharge limit
- \bullet Samples tested at 4000 V_{PK} for 60 sec.; then 1358 V_{PK} for 10 sec. with 5 pC partial discharge limit

Safety-Limiting Values	Symbol	Value	Units
Safety rating ambient temperature	T_{S}	180	°C
Safety rating power (180°C)	P_{S}	270	mW
Supply current safety rating (total of supplies)	I_S	54	mA

IEC 61010-1 (Edition 2; TUV Certificate Numbers N1502812; N1502812-101)

Reinforced Insulation; Pollution Degree II; Material Group III

Part No. Suffix	Package	Working Voltage		
-1	QSOP	$150 V_{RMS}$		
-3	SOIC	$150 V_{RMS}$		
None	Wide-body SOIC/True 8 TM	$300 \mathrm{V}_{\mathrm{RMS}}$		

UL 1577 (Component Recognition Program File Number E207481)

Each part tested at 3000 V_{RMS} (4240 V_{PK}) for 1 second; each lot sample tested at 2500 V_{RMS} (3530 V_{PK}) for 1 minute

Soldering Profile

Per JEDEC J-STD-020C, MSL 1



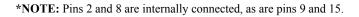


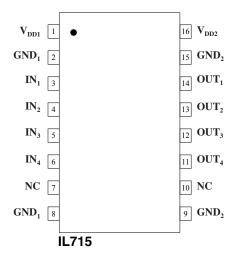
IL715 Pin Connections

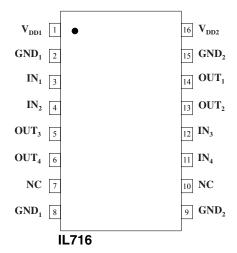
1	V_{DD1}	Supply voltage
2	GND_1	Ground return for V _{DD1} *
3	IN_1	Data in, channel 1
4	IN_2	Data in, channel 2
5	IN_3	Data in, channel 3
6	IN_4	Data in, channel 4
7	NC	No connection
8	GND_1	Ground return for V _{DD1} *
9	GND_2	Ground return for V _{DD2} *
10	NC	No connection
11	OUT ₄	Data out, channel 4
12	OUT ₃	Data out, channel 3
13	OUT ₂	Data out, channel 2
14	OUT ₁	Data out, channel 1
15	GND_2	Ground return for V _{DD2} *
16	V_{DD2}	Supply voltage

IL716 Pin Connections

1	V_{DD1}	Supply voltage
2	GND_1	Ground Return for V _{DD1} *
3	IN_1	Data in, channel 1
4	IN_2	Data in, channel 2
5	OUT ₃	Data out, channel 3
6	OUT_4	Data out, channel 4
7	NC	No connection
8	GND_1	Ground Return for V _{DD1} *
9	GND_2	Ground Return for V _{DD2} *
10	NC	No connection
11	IN_4	Data in, channel 4
12	IN_3	Data in, channel 3
13	OUT ₂	Data out, channel 2
14	OUT_1	Data out, channel 1
15	GND_2	Ground Return for V _{DD2} *
16	V_{DD2}	Supply voltage







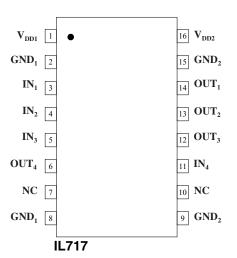
©NVE Corporation





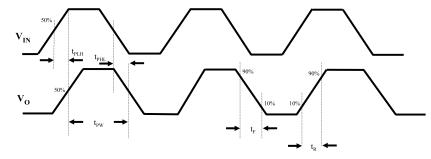
IL717 Pin Connections

<u> </u>	••				
1	V_{DD1}	Supply voltage			
2	GND_1	Ground return for V _{DD1} *			
3	IN_1	Data in, channel 1			
4	IN_2	Data in, channel 2			
5	IN_3	Data in, channel 3			
6	OUT ₄	Data out, channel 4			
7	NC	No connection			
8	GND_1	Ground return for V _{DD1} *			
9	GND_2	Ground return for V _{DD2} *			
10	NC	No connection			
11	IN_4	Data in, channel 4			
12	OUT ₃	Data out, channel 3			
13	OUT ₂	Data out, channel 2			
14	OUT ₁	Data out, channel 1			
15	GND_2	Ground return for V _{DD2} *			
16	V_{DD2}	Supply voltage			



^{*}NOTE: Pins 2 and 8 are internally connected, as are pins 9 and 15.

Timing Diagram



Legend

- 3 -	
$t_{\scriptscriptstyle PLH}$	Propagation Delay, Low to High
t_{PHL}	Propagation Delay, High to Low
t_{PW}	Minimum Pulse Width
t_R	Rise Time
$t_{\scriptscriptstyle F}$	Fall Time





3.3 Volt Electrical Specifications (T_{min} to T_{max} unless otherwise stated)									
Parameters	Symbol	Min.	Тур.	Max.	Units	Test Conditions			
Input Quiescent Supply Current									
IL715 and IL715-3			16	20	μA				
IL715-1	ī		300	400	μA				
IL716	I_{DD1}		2.4	3.5	mA				
IL717			1.2	1.75	mA				
Output Quiescent Supply Current									
IL715			4.8	7	mA				
IL716	I_{DD2}		2.4	3.5	mA				
IL717			3.6	5.25	mA				
Logic Input Current	I_{I}	-10		10	μA				
Logic High Output Voltage	V	$V_{DD} - 0.1$	$V_{ m DD}$		V	$I_{O} = -20 \mu A, V_{I} = V_{IH}$			
Logic High Output Voltage	V_{OH}	$0.8 \times V_{DD}$	$0.9 \times V_{DD}$		V	$I_O = -4 \text{ mA}, V_I = V_{IH}$			
Logia Low Output Voltage	V		0	0.1	V	$I_{O} = 20 \mu A, V_{I} = V_{IL}$			
Logic Low Output Voltage	V_{OL}		0.5	0.8] v	$I_O = 4 \text{ mA}, V_I = V_{IL}$			

Switching Specifications ($V_{DD} = 3.3 \text{ V}$)								
Maximum Data Rate		100	110		Mbps	$C_L = 15 \text{ pF}$		
Pulse Width ⁽⁷⁾	PW	10			ns	50% Points, V _o		
Propagation Delay Input to Output (High to Low)	t_{PHL}		12	18	ns	$C_L = 15 \text{ pF}$		
Propagation Delay Input to Output (Low to High)	$t_{ m PLH}$		12	18	ns	$C_L = 15 \text{ pF}$		
Pulse Width Distortion (2)	PWD		2	3	ns	$C_L = 15 \text{ pF}$		
Propagation Delay Skew (3)	t_{PSK}		4	6	ns	$C_L = 15 \text{ pF}$		
Output Rise Time (10%–90%)	t_{R}		2	4	ns	$C_L = 15 \text{ pF}$		
Output Fall Time (10%–90%)	t_{F}		2	4	ns	$C_L = 15 \text{ pF}$		
Common Mode Transient Immunity (Output Logic High or Logic Low) ⁽⁴⁾	$ CM_H , CM_L $	30	50		kV/μs	$V_{CM} = 1500 V_{DC}$ $t_{TRANSIENT} = 25 \text{ ns}$		
Channel-to-Channel Skew	t_{CSK}		2	3	ns	$C_L = 15 \text{ pF}$		
Dynamic Power Consumption ⁽⁶⁾			140	240	μA/Mbps	per channel		

Magnetic Field Immunity ⁽⁸⁾ $(V_{DD2} = 3V, 3V < V_{DD1} < 5.5V)$						
Power Frequency Magnetic Immunity	H_{PF}	1000	1500		A/m	50Hz/60Hz
Pulse Magnetic Field Immunity	H_{PM}	1800	2000		A/m	$t_p = 8\mu s$
Damped Oscillatory Magnetic Field	H_{OSC}	1800	2000		A/m	0.1Hz – 1MHz
Cross-axis Immunity Multiplier ⁽⁹⁾	K_X		2.5			





5 Volt Electrical Specifications (T_{min} to T_{max} unless otherwise stated)						
Parameters	Symbol	Min.	Тур.	Max.	Units	Test Conditions
Input Quiescent Supply Current						
IL715 and IL715-3			24	30	μΑ	
IL715-1	ī		350	500	μA	
IL716	I_{DD1}		3.6	5	mA	
IL717			1.8	2.5	mA	
Output Quiescent Supply Current						
IL715			7.2	10	mA	
IL716	I_{DD2}		3.6	5	mA	
IL717			5.4	7.5	mA	
Logic Input Current	I_{I}	-10		10	μΑ	
Logic High Output Voltage	V	$V_{DD} - 0.1$	$V_{ m DD}$		V	$I_{O} = -20 \mu A, V_{I} = V_{IH}$
	V_{OH}	$0.8 \times V_{DD}$	$0.9 \times V_{DD}$		v	$I_O = -4 \text{ mA}, V_I = V_{IH}$
Logic Low Output Voltage	V		0	0.1	V	$I_{O} = 20 \mu A, V_{I} = V_{IL}$
	V_{OL}		0.5	0.8		$I_O = 4 \text{ mA}, V_I = V_{II}$

Switching Specifications $(V_{DD} = 5V)$						
Maximum Data Rate		100	110		Mbps	$C_L = 15 \text{ pF}$
Pulse Width ⁽⁷⁾	PW	10			ns	50% Points, V _o
Propagation Delay Input to Output (High to Low)	t_{PHL}		10	15	ns	$C_L = 15 \text{ pF}$
Propagation Delay Input to Output (Low to High)	$t_{\rm PLH}$		10	15	ns	$C_L = 15 \text{ pF}$
Pulse Width Distortion ⁽²⁾	PWD		2	3		$C_L = 15 \text{ pF}$
Pulse Jitter ⁽¹⁰⁾	t _J		100		ps	$C_L = 15 \text{ pF}$
Propagation Delay Skew ⁽³⁾	t_{PSK}		4	6	ns	$C_L = 15 \text{ pF}$
Output Rise Time (10%–90%)	t_R		1	3	ns	$C_L = 15 \text{ pF}$
Output Fall Time (10%–90%)	t_{F}		1	3	ns	$C_L = 15 \text{ pF}$
Common Mode Transient Immunity (Output Logic High or Logic Low) ⁽⁴⁾	CM _H , CM _L	30	50		kV/μs	$V_{CM} = 1500 V_{DC}$ $t_{TRANSIENT} = 25 \text{ ns}$
Channel-to-Channel Skew	t_{CSK}		2	3	ns	$C_L = 15 \text{ pF}$
Dynamic Power Consumption ⁽⁶⁾			200	340	μA/Mbps	per channel

Magnetic Field Immunity ⁽⁸⁾ (V _{DD2} = 5V, 3V <v<sub>DD1<5.5V)</v<sub>						
Power Frequency Magnetic Immunity	H_{PF}	2800	3500		A/m	50Hz/60Hz
Pulse Magnetic Field Immunity	H_{PM}	4000	4500		A/m	$t_p = 8\mu s$
Damped Oscillatory Magnetic Field	H_{OSC}	4000	4500		A/m	0.1Hz – 1MHz
Cross-axis Immunity Multiplier ⁽⁹⁾	K_X		2.5			

Notes (apply to both 3.3 V and 5 V specifications):

- 1. Absolute maximum ambient operating temperature means the device will not be damaged if operated under these conditions. It does not guarantee performance.
- 2. PWD is defined as $|t_{PHL} t_{PLH}|$. %PWD is equal to PWD divided by pulse width.
- 3. t_{PSK} is the magnitude of the worst-case difference in t_{PHL} and/or t_{PLH} between devices at 25°C.
- 4. CM_H is the maximum common mode voltage slew rate that can be sustained while maintaining $V_0 > 0.8 V_{DD2}$. CM_L is the maximum common mode input voltage that can be sustained while maintaining $V_0 < 0.8 V$. The common mode voltage slew rates apply to both rising and falling common mode voltage edges.
- 5. Device is considered a two terminal device: pins 1–8 shorted and pins 9–16 shorted.
- 6. Dynamic power consumption is calculated per channel and is supplied by the channel's input side power supply.
- 7. Minimum pulse width is the minimum value at which specified PWD is guaranteed.
- 8. The relevant test and measurement methods are given in the Electromagnetic Compatibility section on p. 7.
- 9. External magnetic field immunity is improved by this factor if the field direction is "end-to-end" rather than to "pin-to-pin" (see diagram on p. 7).
- 10. 66,535-bit pseudo-random binary signal (PRBS) NRZ bit pattern with no more than five consecutive 1s or 0s; 800 ps transition time.



Application Information

Electrostatic Discharge Sensitivity

This product has been tested for electrostatic sensitivity to the limits stated in the specifications. However, NVE recommends that all integrated circuits be handled with appropriate care to avoid damage. Damage caused by inappropriate handling or storage could range from performance degradation to complete failure.

Electromagnetic Compatibility

IsoLoop Isolators have the lowest EMC footprint of any isolation technology. IsoLoop Isolators' Wheatstone bridge configuration and differential magnetic field signaling ensure excellent EMC performance against all relevant standards.

These isolators are fully compliant with generic EMC standards EN50081, EN50082-1 and the umbrella line-voltage standard for Information Technology Equipment (ITE) EN61000. NVE has completed compliance tests in the categories below:

EN50081-1

Residential, Commercial & Light Industrial

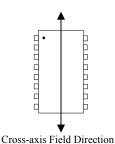
Methods EN55022, EN55014

EN50082-2: Industrial Environment

Methods EN61000-4-2 (ESD), EN61000-4-3 (Electromagnetic Field Immunity), EN61000-4-4 (Electrical Transient Immunity), EN61000-4-6 (RFI Immunity), EN61000-4-8 (Power Frequency Magnetic Field Immunity), EN61000-4-9 (Pulsed Magnetic Field), EN61000-4-10 (Damped Oscillatory Magnetic Field) ENV50204

Radiated Field from Digital Telephones (Immunity Test)

Immunity to external magnetic fields is even higher if the field direction is "end-to-end" rather than to "pin-to-pin" as shown in the diagram below:



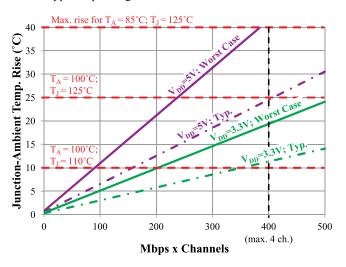
Dynamic Power Consumption

IsoLoop Isolators achieve their low power consumption from the way they transmit data across the isolation barrier. By detecting the edge transitions of the input logic signal and converting these to narrow current pulses, a magnetic field is created around the GMR Wheatstone bridge. Depending on the direction of the magnetic field, the bridge causes the output comparator to switch following the input logic signal. Since the current pulses are narrow, about 2.5 ns, the power consumption is independent of mark-to-space ratio and solely dependent on frequency. This has obvious advantages over optocouplers, which have power consumption heavily dependent on mark-to-space ratio.

Thermal Management

IsoLoop Isolators are designed for low power dissipation and thermal performance, providing unmatched channel density for high-performance isolators. Nevertheless, package temperature rise should be considered when running multiple channels at high speed. Power consumption is higher at 5 volt operation than at 3.3 volts, and dynamic supply current is higher on the input side of the isolators than the output side, so thermal management is more important with five-volt input-side power supplies.

Based on the specifications contained in this datasheet, the derating curve at typical operating conditions is as follows:



Standard-grade parts have a maximum junction temperature of 110°C. T-Series parts have a maximum operating junction temperature of 125°C for additional margin at extreme operating conditions.

Power Supply Decoupling

Both power supplies to these devices should be decoupled with low ESR 47 nF ceramic capacitors. Ground planes for both GND_1 and GND_2 are highly recommended for data rates above 10 Mbps. Capacitors must be located as close as possible to the V_{DD} pins.

Maintaining Creepage

Creepage distances are often critical in isolated circuits. In addition to meeting JEDEC standards, NVE isolator packages have unique creepage specifications. Standard pad libraries often extend under the package, compromising creepage and clearance. Similarly, ground planes, if used, should be spaced to avoid compromising clearance. Package drawings and recommended pad layouts are included in this datasheet.

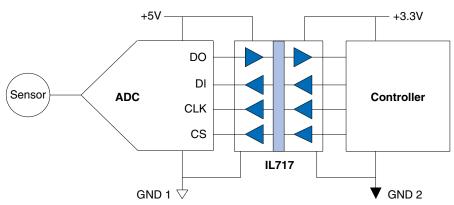
Signal Status on Start-up and Shut Down

To minimize power dissipation, input signals are differentiated and then latched on the output side of the isolation barrier to reconstruct the signal. This could result in an ambiguous output state depending on power up, shutdown and power loss sequencing. Therefore, the designer should consider including an initialization signal in the start-up circuit. Initialization consists of toggling the input either high then low, or low then high.

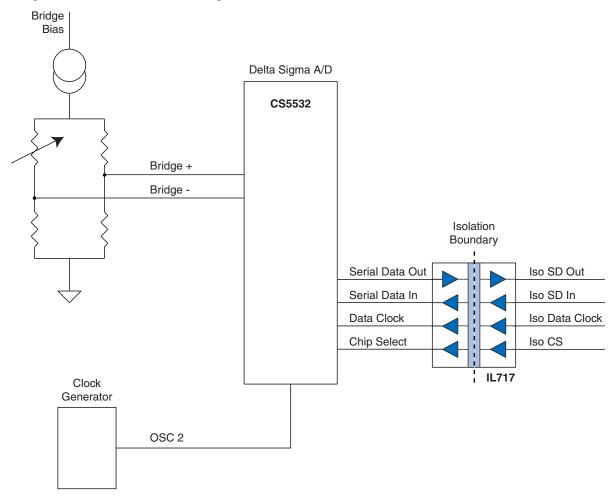


Application Diagrams

Isolated Logic Level Shifters



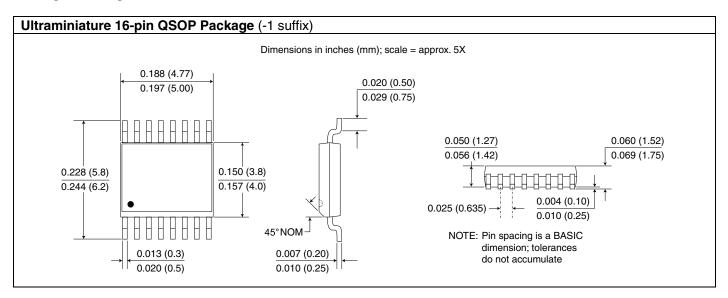
Single-Channel Isolated Delta-Sigma A/D Converter

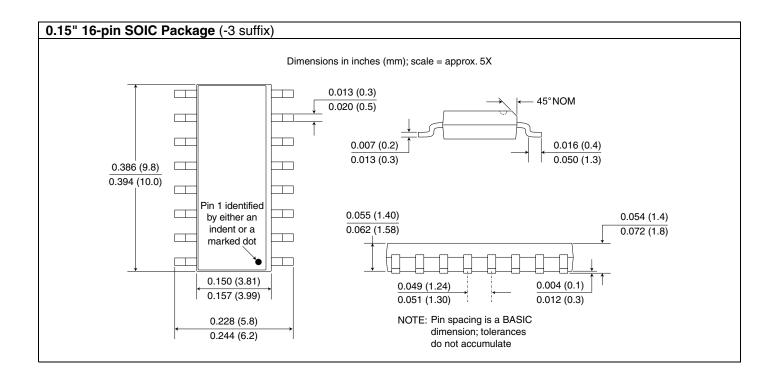


This circuit illustrates a typical single-channel delta-sigma ADC. The A/D is located on the bridge with no signal conditioning electronics between the bridge sensor and the ADC. In this case, the IL717 is the best choice for isolation. It isolates the control bus from the microcontroller. The system clock is located on the isolated side of the system.



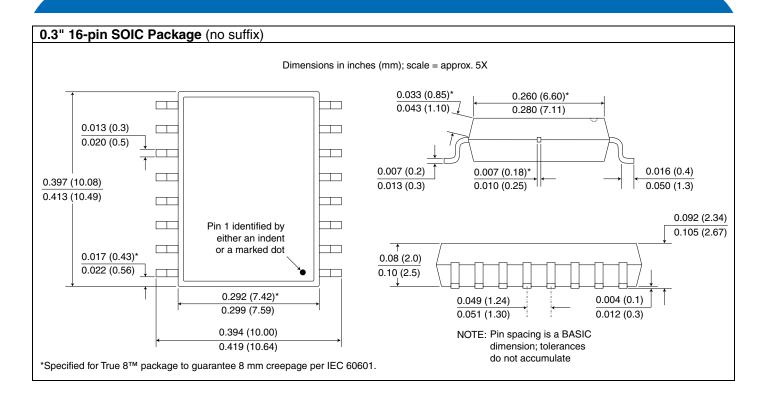
Package Drawings







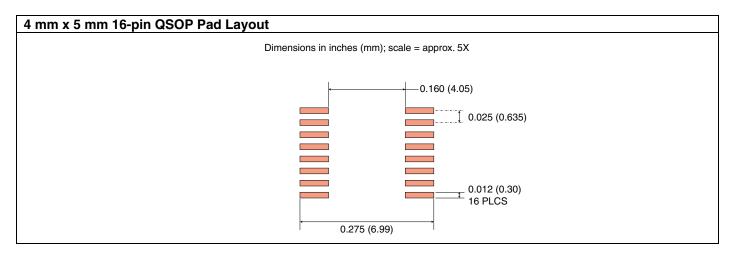


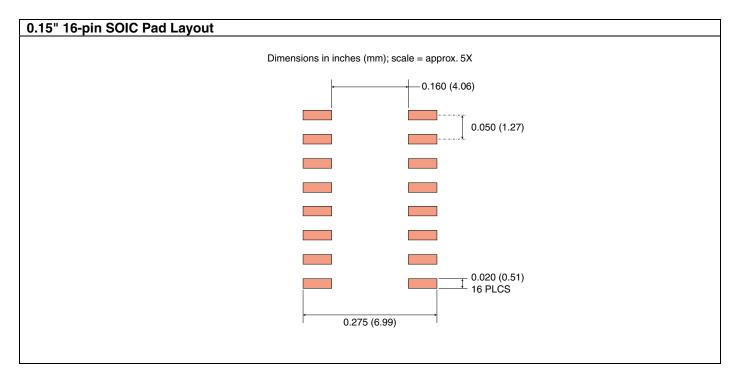






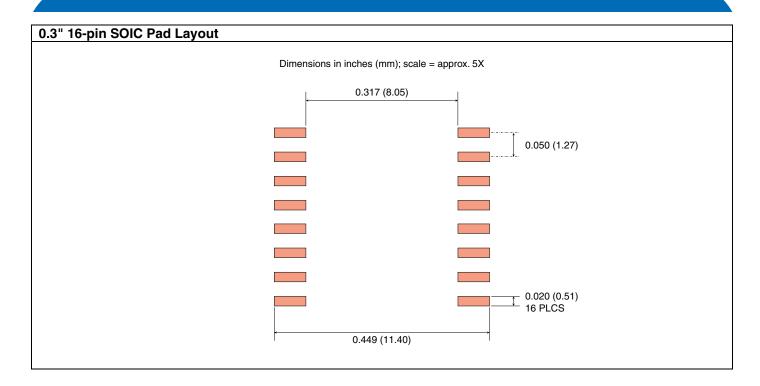
Recommended Pad Layouts





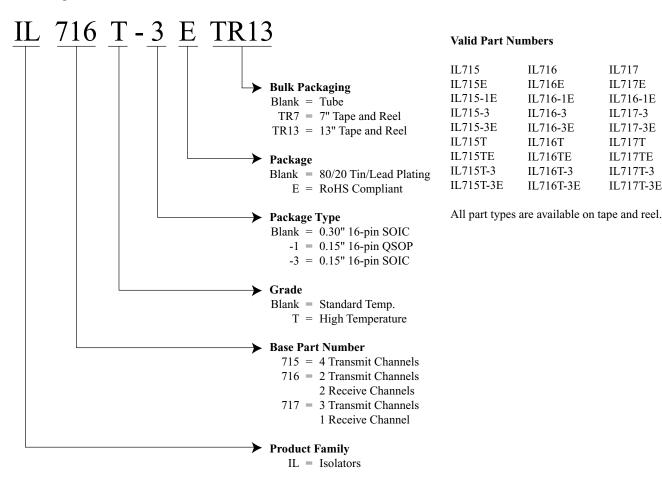








Ordering Information and Valid Part Numbers







ISB-DS-001-IL715/6/7-Z March 2014	ChangesAdded package illustrations on first page.
	• Added QSOP packages (-1 suffix).
	• Revised and added details to thermal characteristic specifications (p. 2).
	• Added VDE 0884 Safety-Limiting Values (p. 3).
	Added "Thermal Management" paragraph in Applications section.
ISB-DS-001-IL715/6/7-Y	Changes • IEC 60747-5-5 (VDE 0884) certification.
ISB-DS-001-IL715/6/7-X	ChangesTighter quiescent current specifications.
	Upgraded from MSL 2 to MSL 1.
ISB-DS-001-IL715/6/7-W	 Changes Increased transient immunity specifications based on additional data.
	Added VDE 0884 pending.
	Added high voltage endurance specification.
	 Increased magnetic immunity specifications.
	Updated package drawings.
	Added recommended solder pad layouts.
ISB-DS-001-IL715/6/7-V	ChangesDetailed isolation and barrier specifications.
	Cosmetic changes.
ISB-DS-001-IL715/6/7-U	 Changes Tightened typical output quiescent supply spec. to 1.5 mA/channel at 3.3V.
ISB-DS-001-IL715/6/7-T	ChangesUpdates to terms and conditions.
ISB-DS-001-IL715/6/7-S	 Changes Added clarification of internal ground connections (pp. 3-4).
ISB-DS-001-IL715/6/7-R	ChangesAdded typical jitter specification at 5V.
ISB-DS-001-IL715/6/7-Q	Changes • Added EMC details.
ISB-DS-001-IL715/6/7-P	 Changes Added magnetic field immunity and electromagnetic compatibility specifications. Added notes on package drawings that pin-spacing tolerances are non-accumulating.





Datasheet Limitations

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